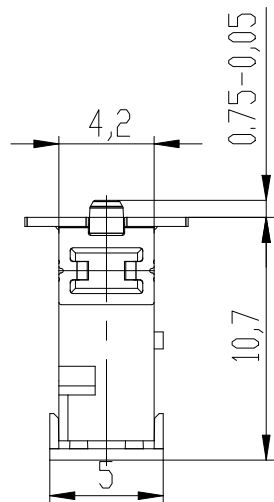
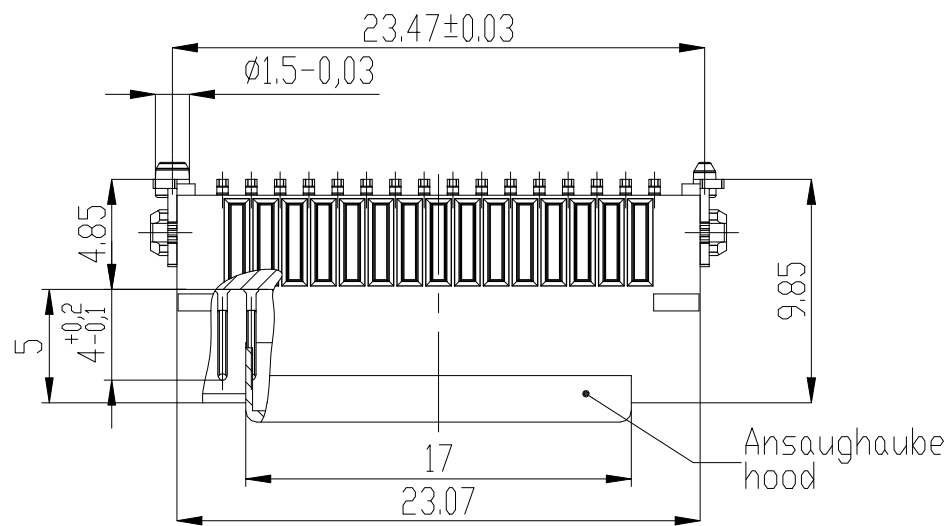
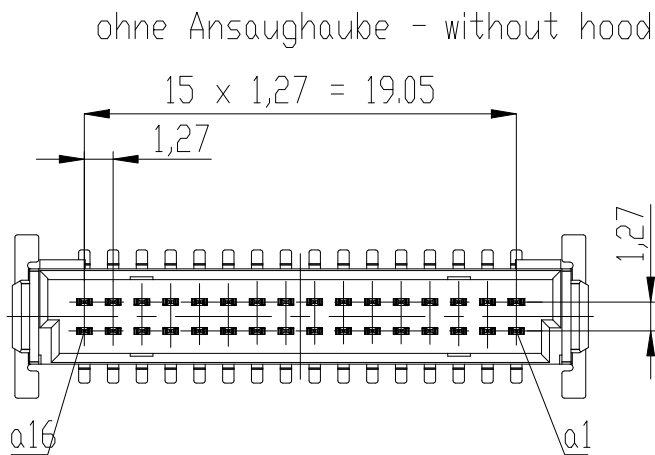
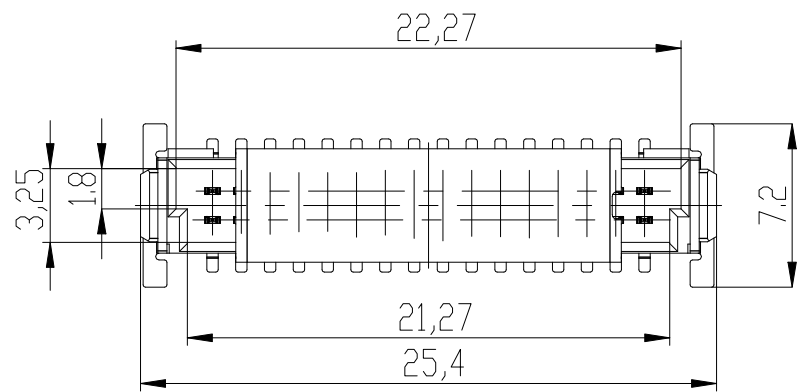
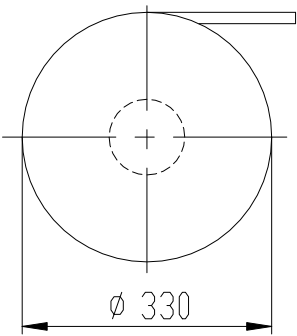
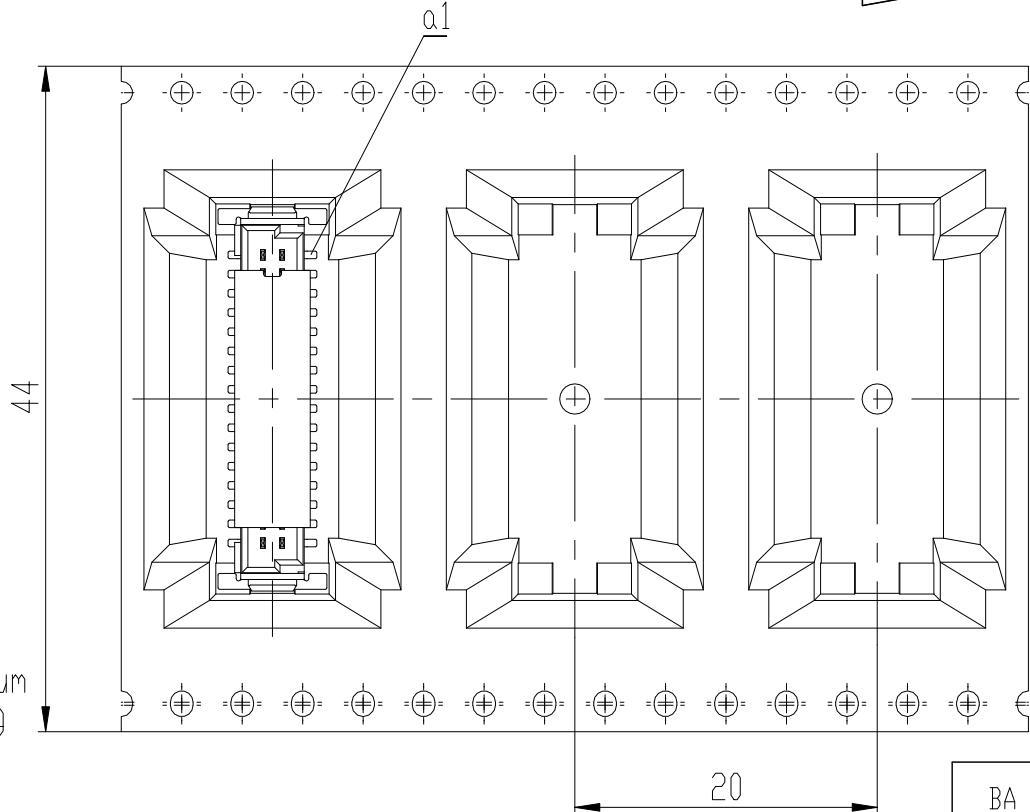


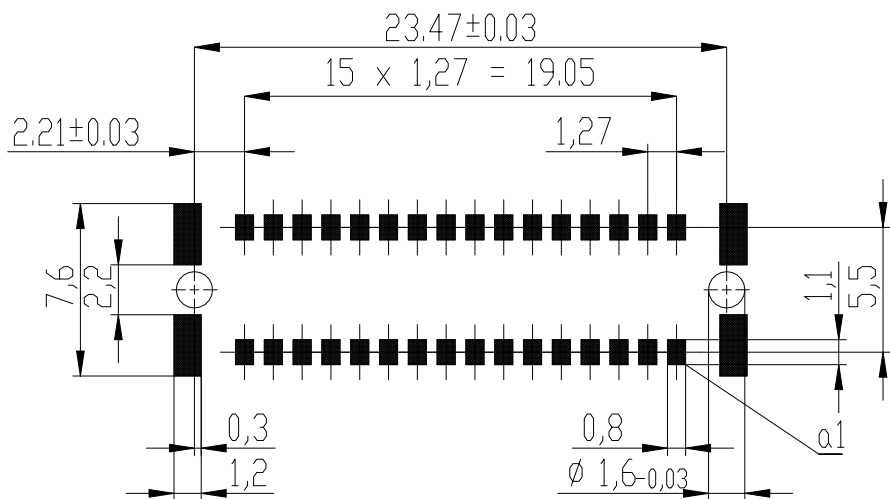
Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
tape on reel packaging according to DIN IEC 60286-3
Verpackungseinheit: 250 Stück
packaging unit: 250 pcs



Abspulrichtung - Reel off Direction



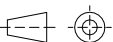
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Anforderungsstufe 1
performance level 1
Kontaktbereich vergoldet
mating area gold plating
Anschlussbereich verzinkt 4-6 µm
terminal area 4-6 µm tin plating
Koplanarität der Anschlüsse
coplanarity area of termination

BA 8-23 - hohe Bauhöhe
type 8-23 - High Profile

Copyright by TE Production GmbH & Co. KG
Proprietary notice pursuant to ISO 15016 to be observed.

Information:				Tolerances		 All Dimensions in mm		Scale 3:1			
Customer drawing:				Subject to modification without prior notice. Drawing will not be updated.				Designation			
THIS DRAWING IS A CONTROLLED DOCUMENT.								ERNI-Messerl. SMC-Q 32-SMD-BA8-23 Male SMC-Q 32-SMD-type8-23			
				 TE Connectivity				C- 254416-E			I
											A3
f				06.11.2018				Class		SMCQ	
Index				Date							

Copyright by TE Production GmbH & Co. KG
Proprietary notice pursuant to ISO 1615 to be observed.



©- 254416-E

I

A3